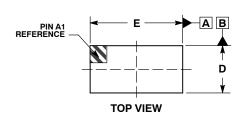
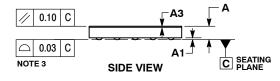
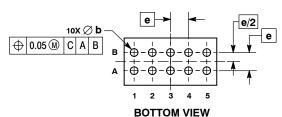


WLCSP10, 1.04x2.04x0.265 CASE 567TH **ISSUE O**

DATE 29 DEC 2016



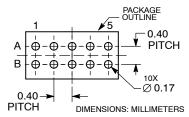




- NOTES:
 1. DIMENSIONING AND TOLERANCING PER
- ASME Y14.5M, 1994.
 CONTROLLING DIMENSION: MILLIMETERS.
 COPLANARITY APPLIES TO THE SPHERICAL
 CROWNS OF THE SOLDER BALLS.

| | MILLIMETERS | | | |
|-----|-------------|-------|-------|--|
| DIM | MIN | NOM | MAX | |
| Α | 0.240 | 0.265 | 0.290 | |
| A1 | 0.040 REF | | | |
| АЗ | 0.025 REF | | | |
| b | 0.12 | 0.17 | 0.22 | |
| D | 0.99 | 1.04 | 1.09 | |
| E | 1.99 | 2.04 | 2.09 | |
| е | 0.40 BSC | | | |

RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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|------------------|--------------------------|---|-------------|--|
| DESCRIPTION: | WLCSP10, 1.04X2.04X0.265 | | PAGE 1 OF 1 | |

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